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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

10/056906
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18/8

APPL NUM 10056906	FILING DATE 01/24/2002	CLASS 412	SUBCLASS 866.1	GAU 3552	EXAMINER CARPEN
**APPLICANTS: Renken Wayne; <i>X 13/866</i>					
**CONTINUING DATA VERIFIED:					
**FOREIGN APPLICATIONS VERIFIED:					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials		ATTORNEY DOCKET NO M-12467			
TITLE : Process condition sensing wafer and data analysis system					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Assistant Examiner	Total Claims Print Claim for O.G.
ISSUE FEE		Primary Examiner	DRAWING
Amount Due	Date Paid		Sheets Drwg. Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner
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